

<b>CERTIFICATE OF TRANSMISSION BY FACSIMILE (37 CFR 1.8)</b>				Docket No. FIS920030278US1
Applicant(s): TIEN-JEN CHANG ET AL.				
Application No. 10/707,047	Filing Date 11/18/2003	Examiner L. VAN	Group Art Unit 1753	
Invention: METHOD FOR SELECTIVE ELECTRO-PLATING OF SEMICONDUCTOR DEVICE I/O PADS USING A TITANIUM-TUNGSTEN SEED LAYER				
<p>I hereby certify that this <b>Transmittal and Amendment</b> (Identify type of correspondence) is being facsimile transmitted to the United States Patent and Trademark Office (Fax. No. <b>571-273-8300</b>)</p> <p>01 03/17/2006 (Date)</p> <p><b>Jessica L. Huston</b> (<i>Typed or Printed Name of Person Signing Certificate</i>) <i>Jessica L. Huston</i> (<i>Signature</i>)</p>				
<p>Note: Each paper must have its own certificate of mailing.</p>				

<b>AMENDMENT TRANSMITTAL LETTER (Large Entity)</b> Applicant(s): TIEN-JEN CHANG ET AL.					Docket No. FIS920030278US1	
Application No.	Filing Date	Examiner	Customer No.	Group Art Unit	Confirmation No.	
10/767,047	11/18/2003	L. VAN	29371	1753	1046	
Invention: <b>METHOD FOR SELECTIVE ELECTRO-PLATING OF SEMICONDUCTOR DEVICE I/O PADS USING A TITANIUM-TUNGUS SEED LAYER</b>						
<b>COMMISSIONER FOR PATENTS:</b>						
Transmitted herewith is an amendment in the above-identified application.						
The fee has been calculated and is transmitted as shown below.						
<b>CLAIMS AS AMENDED</b>						
TOTAL CLAIMS	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE	
10/767,047	14	20	= 0	x \$50.00	\$0.00	
INDEP. CLAIMS	2	3	= 0	x \$200.00	\$0.00	
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>						
<b>TOTAL ADDITIONAL FEE FOR THIS AMENDMENT</b>						
<input checked="" type="checkbox"/> No additional fee is required for amendment. <input type="checkbox"/> Please charge Deposit Account No. in the amount of <input type="checkbox"/> A check in the amount of to cover the filing fee is enclosed. <input checked="" type="checkbox"/> The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account 09-0458 <input checked="" type="checkbox"/> Any additional filing fees required under 37 C.F.R. 1.16. <input type="checkbox"/> Any patent application processing fees under 37 CFR 1.17. <input type="checkbox"/> Payment by credit card. Form PTO-2038.						
WARNING: Information on this form may become public. Credit card information should not be included on this form. Provide credit card information and authorization on PTO-2038.						
 Signature						
Dated: March 17, 2006						
I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on (Date)						
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Typed or Printed Name of Person Mailing Correspondence						
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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: TIEN-JEN CHANG, ET AL. )  
Serial No.: 10/707,047 ) Group Art Unit: 1753  
Filed: November 18, 2003 )  
For: METHOD FOR SELECTIVE ELECTRO- ) Examiner: Van, L.  
PLATING OF SEMICONDUCTOR )  
DEVICE I/O PADS USING A ) Confirmation No.: 1046  
TITANIUM-TUNGSTEN SEED LAYER )

AMENDMENT AFTER FINAL

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

In response to the Final Office Action mailed February 27, 2006, please amend the Application as follows: